

Bill of Materials

TI DESIGN:

TIDA-00189

Designator	Quantity	Value	Description	PackageReference	PartNumber	Manufacturer	Alternate PartNumber	Alternate Manufacturer
!PCB1	1		Printed Circuit Board		TIDA-00189	Any		
C1	1	0.01uF	CAP, CERM, 0.01uF, 10V, +/-10%, X5R, 0402	0402	GRM155R61A103KA01D	MuRata		
C5		0.47uF	CAP, CERM, 0.47uF, 100V, +/-10%, X7R, 0805	0805	GRM21BR72A474KA73L	MuRata		
C6	1	0.01uF	CAP, CERM, 0.01uF, 100V, +/-10%, X7R, 0603	0603	GRM188R72A103KA01D	MuRata		
C7	1	2.2uF	CAP, CERM, 2.2uF, 16V, +/-10%, X5R, 0402	0402	C1005X5R1C225K050BC	TDK		
C10, C12, C15	3	10uF	CAP, CERM, 10uF, 10V, +/-10%, X7R, 0805	0805	GRM21BR71A106KE51L	MuRata		
C11, C52	2	0.1uF	CAP, CERM, 0.1uF, 10V, +/-10%, X5R, 0402	0402	GRM155R61A104KA01D	MuRata		
C13, C17,		1uF	CAP, CERM, 1uF, 10V, +/-10%, X5R, 0402	0402	GRM155R61A105KE15D	MuRata		
C19, C20, C21, C22, C23, C37,								
C43		20	CAD CEDM 200-E 40V 1/400/ VED 4000	1206	CDM04CDC4A00CKE40L	M. D. I.		
C14		22uF	CAP, CERM, 22uF, 10V, +/-10%, X5R, 1206		GRM31CR61A226KE19L	MuRata		
C16		4.7uF	CAP, CERM, 4.7uF, 10V, +/-20%, X5R, 0402	0402	GRM155R61A475M	MuRata		
C24, C25		2.2uF	CAP, CERM, 2.2uF, 10V, +/-10%, X7R, 0603	0603	GRM188R71A225KE15D	MuRata		
C26, C27, C45, C47, C49	5	0.1uF	CAP, CERM, 0.1uF, 6.3V, +/-10%, X7R, 0402	0402	GRM155R70J104KA01D	MuRata		
C28, C29	2	0.1uF	CAP, CERM, 0.1uF, 16V, +/-10%, X7R, 0402	0402	GRM155R71C104KA88D	MuRata		
C30, C33		1000pF	CAP, CERM, 0.10F, 16V, +/-10%, X7R, 0402	0402	GRM155R71C104KA00D	MuRata		
C30, C33	1	0.1uF	CAP, CERM, 1000PF, 16V, +/-10%, X7R, 0402	1206	12061C104JAT2A	AVX		
C32		1uF	CAP, CERM, 0.10F, 100V, +/-5%, X7R, 1206 CAP, CERM, 1uF, 100V, +/-10%, X7R, 1206	1206	GRM31CR72A105KA01L	MuRata		
C34, C35,		2200pF	CAP, CERM, 10F, 100V, +/-10%, X/R, 1208 CAP, CERM, 2200pF, 6.3V, +/-10%, X/R, 0402	0402	GRM155R70J222KA01D	MuRata		
C36, C53		·						
C38, C42		0.27uF	CAP, CERM, 0.27uF, 6.3V, +/-10%, X5R, 0402	0402	GRM155R60J274KE01D	MuRata		
C39, C40		0.22uF	CAP, CERM, 0.22uF, 6.3V, +/-10%, X5R, 0402	0402	GRM155R60J224KE01D	MuRata		
C41		4.7uF	CAP, CERM, 4.7uF, 6.3V, +/-10%, X5R, 0603	0603	GRM188R60J475KE19D	MuRata		
C44		0.47uF	CAP, CERM, 0.47uF, 6.3V, +/-10%, X7R, 0603	0603	GRM188R70J474KA01D	MuRata		
C46, C48, C50	3	10uF	CAP, CERM, 10uF, 6.3V, +/-20%, X5R, 0402	0402	CL05A106MQ5NUNC	Samsung		
C51	1	3.3uF	CAP, CERM, 3.3uF, 10V, +/-10%, X5R, 0603	0603	GRM188R61A335KE15D	MuRata		
D1, D5	2	100V	Diode, Schottky, 100V, 0.25A, SOD-323F	SOD-323F	BAT46WJ,115	NXP Semiconductor		
D2, D4	2	90V	Diode, Switching, 90V, 0.1A, SOD-523F	SOD-523F	CDSU101A	Comchip Technology		
D3	1	39V	Diode, TVS, Bi, 39V, 600W, SMB	SMB	SM6T39CA	ST Microelectronics		
D6, D7	2	75V	Diode, Fast Rectifier, 75V, 0.2A, 3.7x1.6x1.6mm	3.7x1.6x1.6mm	PMLL4153,115	NXP Semiconductor		
D8	1	3.9V	Diode, Zener, 3.9V, 500mW, SOD-123	SOD-123	MMSZ4686T1G	ON Semiconductor		
D9	1		TVS DIODE 3.3VWM 7.8VC SOD923	SOD-923	ESD9R3.3ST5G	ON Semiconductor		
H1, H2, H3, H4	4		Machine Screw, Round, #4-40 x 1/4, Nylon, Philips panhead	Screw	NY PMS 440 0025 PH	B&F Fastener Supply		
H5, H6, H7, H8	4		Standoff, Hex, 0.5"L #4-40 Nylon	Standoff	1902C	Keystone		
J1, J3	2		Terminal Block, 6A, 3.5mm Pitch, 2-Pos, TH	7.0x8.2x6.5mm	ED555/2DS	On-Shore Technology		

Designator	Quantity	Value	Description	PackageReference	PartNumber	Manufacturer	Alternate PartNumber	Alternate Manufacturer
J2	1		Header, 100mil, 2x1, Tin plated, TH	Header 2x1	90120-0122	Molex		
J6, J7	2		Header, 100mil, 3x1, 7m plated, 7H	Header, 3 PIN, 100mil, Tin		Sullins Connector Solutions		
J8	1		Header (shrouded), 100 mil, 7x2, Gold plated, TH	7x2 Shrouded Header	SBH11-PBPC-D07-ST-BK	Sullins Connector Solutions		
L1. L3	2	47uH	Inductor, Wirewound, Ferrite, 47uH, 0.11A, 1.235 ohm.	2.5x1.8x1.8mm	CB2518T470K	Taivo Yuden		
,	_		SMD			,.		
L2	1	470uH	Coupled inductor, 470uH, 0.1A, 0.35 ohm, +/-30%, SMD	5.0x3.3x3.3mm	DR221-474AE	Bourns		
L4	1	33uH	Inductor, Wirewound, Ferrite, 33uH, 0.13A, 0.7 ohm, SMD	2.5x1.8x1.8mm	CB2518T330K	Taiyo Yuden		
L5	1	600 ohm	Ferrite Bead, 600 ohm @ 100MHz, 0.2A, 0603	0603	BLM18HG601SN1D	MuRata		
Q1	1	V	Transistor, NPN, 80V, 1A, SOT1061	SOT1061	BC56-16PA,115	NXP Semiconductor		
R1	1	200	RES, 200 ohm, 1%, 0.25W, 1206	1206	CRCW1206200RFKEA	Vishay-Dale		
R3	1	100k	RES, 100k ohm, 1%, 0.063W, 0402	0402	CRCW0402100KFKED	Vishay-Dale		
R4	1	698k	RES, 698k ohm, 1%, 0.063W, 0402	0402	CRCW0402698KFKED	Vishay-Dale		
R8	1	237k	RES, 237k ohm, 1%, 0.063W, 0402	0402	CRCW0402237KFKED	Vishay-Dale		
R10, R13	2	499k	RES, 499k ohm, 1%, 0.063W, 0402	0402	CRCW0402499KFKED	Vishay-Dale		
R11, R32,	3		RES, 1.00k ohm, 1%, 0.063W, 0402	0402	CRCW04021K00FKED	Vishay-Dale		
R36		_						
R12	1	0	RES, 0 ohm, 5%, 0.1W, 0603	0603	CRCW06030000Z0EA	Vishay-Dale		
R15, R17, R18, R21, R22, R28, R29, R38, R39, R40,	11	10.0	RES, 10.0 ohm, 1%, 0.1W, 0603	0603	CRCW060310R0FKEA	Vishay-Dale		
R42	_	0	DEO 0 1 1 2 50/ 0 000 W 0400	0.400	000000000000000000000000000000000000000	N		
R19, R20	2	0	RES, 0 ohm, 5%, 0.063W, 0402	0402	CRCW04020000Z0ED	Vishay-Dale		
R23 R24, R27	2	100 40.2	RES, 100 ohm, 0.1%, 0.1W, 0603 RES, 40.2 ohm, 1%, 0.063W, 0402	0603 0402	RT0603BRD07100RL CRCW040240R2FKED	Yageo America Vishay-Dale		
R25	1	20.0	RES, 20.0 ohm, 1%, 0.1W, 0603	0603	CRCW040240R2FRED	Vishay-Dale Vishay-Dale		
R26	1	Δ0.0	RES, 0 ohm, 5%, 0.25W, 1206	1206	CRCW12060000Z0EA	Vishay-Dale Vishay-Dale		
R30, R37	2	2.00Meg	RES, 2.00Meg ohm, 1%, 0.063W, 0402	0402	CRCW04022M00FKED	Vishay-Dale Vishay-Dale		
R31	1	3.24k	RES, 3.24k ohm, 0.1%, 0.333W, 1206	1206	PFC-W1206R-12-3241-B	TT Electronics/IRC		
R33, R34, R35	3		RES, 47 ohm, 5%, 0.063W, 0402	0402	CRCW040247R0JNED	Vishay-Dale		
R41, R46	2	1.0Meg	RES, 1.0Meg ohm, 5%, 0.063W, 0402	0402	CRCW04021M00JNED	Vishay-Dale		
R43	1	47k	RES, 47k ohm, 5%, 0.063W, 0402	0402	CRCW040247K0JNED	Vishay-Dale		
R44	1	2.00k	RES, 2.00k ohm, 1%, 0.063W, 0402	0402	CRCW04022K00FKED	Vishay-Dale		
S1, S2	2		Switch, Push Button, SMD	2.9x2x3.9mm SMD	SKRKAEE010	Alps		
SH-J2, SH- J3	2	1x2	Shunt, 100mil, Gold plated, Black	Shunt	969102-0000-DA	ЗМ	SNT-100-BK-G	Samtec
T1	1	3mH	Transformer, 3mH, SMT	9.78x10.54x9.14mm	750314839	Wurth Elektronik eiSos		
T3	1	400uH	Transformer_400uH, SMT	8.89x5.46x6.99mm	S5394-CLB	Coilcraft		
TC1	1	100 Ohm	Temperature Sensor, 100 ohm, 1%, 1206	1206	PTS120601B100RP100	Vishay/Beyschlag		
TP1, TP3, TP8, TP9, TP10	5	Red	Test Point, Miniature, Red, TH	Red Miniature Testpoint	5000	Keystone		
TP2, TP6, TP11	3	White	Test Point, Miniature, White, TH	White Miniature Testpoint	5002	Keystone		
TP4, TP5, TP7	3	Black	Test Point, Miniature, Black, TH	Black Miniature Testpoint	5001	Keystone		
U1	1		60-V, 5-μA IQ, 100-mA, Low-Dropout Voltage Regulator with Enable and Power-Good, DRB0008A	DRB0008A	TPS7A1601DRB	Texas Instruments		None
U2	1	_	UNREGULATED 60-mA CHARGE PUMP VOLTAGE INVERTER, DBV0005A	DBV0005A	TPS60402DBV	Texas Instruments		None

Designator	Quantity	Value	Description	PackageReference	PartNumber	Manufacturer	Alternate PartNumber	Alternate Manufacturer
U3, U4	2		Low Noise, High-Bandwidth PSRR Low-Dropout 150mA Linear Regulator, DSE0006A	DSE0006A	TPS71733DSE	Texas Instruments		None
U5	1		Single-Wire 16-bit DAC for 4-20mA loops, RGH0016A	RGH0016A	DAC161P997CISQ/NOPB	Texas Instruments		None
U6	1		Low-Power, Low-Noise, 24-Bit Analog-to-Digital Converter for Small Signal Sensors, RVA0016A	RVA0016A	ADS1220IRVA	Texas Instruments		None
U7	1		Mixed Signal Microcontroller, RSB0040B	RSB0040B	MSP430F5172IRSB	Texas Instruments		None
U8	1		QUADRUPLE BUS BUFFER GATE WITH 3-STATE OUTPUTS, RGY0014A	RGY0014A	SN74LVC125ARGY	Texas Instruments		None
C2, C3, C4, C8, C9	0	10uF	CAP, CERM, 10uF, 10V, +/-10%, X7R, 0805	0805	GRM21BR71A106KE51L	MuRata		
C18	0	560pF	CAP, CERM, 560pF, 50V, +/-10%, X7R, 0402	0402	GRM155R71H561KA01D	MuRata		
FID1, FID2, FID3, FID4, FID5, FID6	0		Fiducial mark. There is nothing to buy or mount.	Fiducial	N/A	N/A		
R2, R9	0	0	RES, 0 ohm, 5%, 0.125W, 0805	0805	CRCW08050000Z0EA	Vishay-Dale		
R5, R6, R7	0	200	RES, 200 ohm, 1%, 0.063W, 0402	0402	CRCW0402200RFKED	Vishay-Dale		
R14	0	10.0	RES, 10.0 ohm, 1%, 0.063W, 0402	0402	CRCW040210R0FKED	Vishay-Dale		

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